

DIN 41612 Headers and Receptacles

HARSH ENVIRONMENT CONNECTOR WITH BOARD-TO-BOARD AND I/O CAPABILITY

DIN 41612 connector systems are the most popular backplane interconnect systems in IEC 603-2 specifications due to the widespread standard adoption, easy availability, cost-effectiveness, and durability.

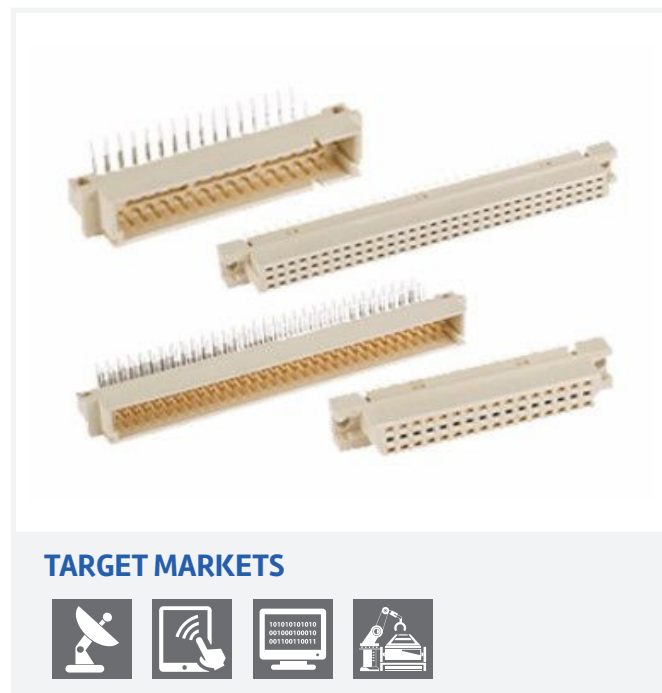
The product design for Board-to-Board and I/O solutions involve both standard mount and reverse mount mating combination.

These connectors are available in up to three rows and maximum 96 positions with solder, press-fit, and reflow compatible pin-in paste terminations.

- Standard mount and reverse mount options available
- Revolutionary beam-on-beam contact interface
- Available in press-fit, solder-to-board, and pin-in-paste terminations

FEATURES

- Available in 2.54 mm and 5.08 mm pitch
- Follows modular system
- Selective loading pattern for contacts
- FMLB and LMEB contacts
- A wide range of accessories available
- Rear Plug-Up (RPU) capability



BENEFITS

- Compatible to industry standard and hence inter-mateable & interchangeable
- Standardized and cost-effective solutions
- Improves creepage distance, facilitates custom loading
- Flexibility in grounding options
- Enhances connector suitability and flexibility
- Promotes extended mating applications via shrouds on the rear side of the PCB

TECHNICAL INFORMATION

MATERIAL

- Insulator: Polyester thermoplastic
- Housings can withstand exposure to lead-free wave soldering temperature of 260 °C to 265 °C when used along with high temperature adhesive or protective metallic device for right angle connectors
- Contact: Copper Alloy (male & female contact)
- Plating: Lead-free version
- Male & Female Contacts (DIN 41612 compliant):
 - Active contact areas selectively plated
 - Gold over Nickel or GXT® over Nickel on mating surface
 - Tin over Nickel on solder termination

MECHANICAL PERFORMANCE

- Mating Insertion Force per Contact: ≤ 0.94 N
- Mating Extraction Force per Contact: ≥ 0.15 N
- Contact Retention in Insulator: ≥ 20 N
- Vibration: ≤ 1 μ s according to IEC-4 test
- Shock: ≤ 1 μ s according to IEC-4 test

ELECTRICAL PERFORMANCE

- Current Rating at 20 °C: 1.5 A
- Maximum Current: 2 A
- Contact Resistance: ≤ 20 m Ω
- Insulation Resistance: $\geq 10^6$ M Ω
- Test Voltage (rms): 1000 V
- Creepage and Clearance Distance: ≥ 1.2 mm
- Wiping/Plug-in Direction: ≥ 1.8 mm

ENVIRONMENTAL

- Temperature Range: -55 °C to +125 °C
- Damp Heat:
 - Steady state 56 days: Class 1
 - Steady state 21 days: Class 2
 - Not applicable: Class 3

SPECIFICATIONS

- DIN 41612
- IEC 603-2

PACKAGING

- Tray
- Tube
- Carton

ARPROVALS AND CERTIFICATIONS

- UL
- NFF 16-101/102
- EN45545-2

TARGET MARKETS/APPLICATIONS



Switching/Routing
Enterprise
Transmission
Access – wired/wireless



Home Entertainment
White Goods
Phones



Servers
Personal Computing
Peripheral Device



Medical
Lighting
Process Control
Transportation
Instrumentation
Vehicle Electronics
Energy Transmission/Distribution Control

PART NUMBERS

Find part number details using the search box on www.amphenol-cs.com

Style	Connector	Configuration	Rows Loaded	Termination	Part Numbers
C	Right Angle Header	2 row / 64 pos.	a & c	Solder-to-board	860946471137*5ELF
				Press-fit	860946471947*5E1LF
		3 row / 96 pos.	a, b, c	Solder-to-board	860939671137*5ELF
				Press-fit	860939671947*5E1LF
	Straight Receptacle	2 row / 64 pos.	a & c	Solder-to-board	860946481147*5V1LF
				Press-fit	860946481947*5E3LF
		3 row / 96 pos.	a, b, c	Solder-to-board	860939681147*5V1LF
				Press-fit	860939681947*5E3LF
C/2	Right Angle Header	2 row / 32 pos.	a, b, c	Solder-to-board	860943273137*5ELF
		3 row / 48 pos.	a & c		860934873137*5ELF
	Straight Receptacle	2 row / 32 pos.	a, b, c	Solder-to-board	860934883147*5V1LF
		3 row / 48 pos.		Press-fit	860934883947*5E3LF
B	Right Angle Header	1 row / 32 pos.	a only	Solder-to-board	860913251137*5ELF
		2 row / 64 pos.	a & b		860926451137*5ELF
	Straight Receptacle	1 row / 32 pos.	a only		860913261147*5V1LF
		2 row / 64 pos.	a & b		860926461147*5V1LF
B/2	Right Angle Header	2 row / 32 pos.	a & b	Solder-to-board	860923253137*5ELF
	Straight Receptacle				860923263147*5E1LF
R	Straight Header	2 row / 64 pos.	a & c	Solder-to-board	860946478147*5ELF
				Press-fit	860946478947*5E1LF
		3 row / 96 pos.	a, b, c	Solder-to-board	860939678147*5ELF
				Press-fit	860939678947*5E1LF
	Right Angle Receptacle	2 row / 64 pos.	a & c	Solder-to-board	860946488137*5V1LF
				Press-fit	860946488947*5E3LF
		3 row / 96 pos.	a, b, c	Solder-to-board	860939688137*5V1LF
				Press-fit	860939688947*5E3LF
R/2	Straight Header	2 row / 32 pos.	a & c	Solder-to-board	860943276147*5ELF
		3 row / 48 pos.	a, b, c	Solder-to-board	860934876147*5ELF
				Press-fit	860934876947*5E1LF
	Right Angle Receptacle	2 row / 32 pos.	a & c	Solder-to-board	860943286137*5E1LF
		3 row / 48 pos.	a, b, c		860934886137*5E1LF
Q	Straight Header	2 row / 64 pos.	a & b	Solder-to-board	860926458147*5ELF

Note: Asterisk () in part number denotes Performance class: PN Code 6,5,4 for Class 1, 2 & 3 respectively. Custom loading and other options available on request.

WHERE INNOVATION CONNECTS

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BCSDIN41612HR0625EA4